		•		
L Number	Hits		DB	Time stamp
1	2	(wood wooden cellulosic fiber\$1board	USPAT;	2003/07/15 10:42
1		chip\$1board partcile\$1board hard\$1board	EPO; JPO;	
1		flake\$1board strand\$1board wafer\$1board)	DERWENT	
2	0	and (pre\$1paint with seal\$3) (wood wooden cellulosic fiber\$1board	HEOCE	2002/07/15 00.44
2	U	chip\$lboard partcile\$lboard hard\$lboard	USOCR	2003/07/15 09:44
		flake\$1board strand\$1board wafer\$1board)		
		and (pre\$lpaint with seal\$3)		
3	0		USOCR	2003/07/15 09:46
	_	fiber-board "fiber board" chipboard		
		chip-board "chip board" particleboard		
		particle-board "particle board" hardboard		
		hard-board "hard board" flakeboard		
		flake-board "flake board" strandboard		
		strand-board "strand board" waferboard		
		wafer-board "wafer board") and ((prepaint		
		<pre>pre-paint "pre paint") with (seal sealed sealer sealant sealing))</pre>		
4	70	j	USOCR	2003/07/15 10:02
."	. ,0	fiber-board "fiber board" chipboard	USOCK	2003/07/13 10:02
		chip-board "chip board" particleboard		
		particle-board "particle board" hardboard		i
		hard-board "hard board" flakeboard		
		flake-board "flake board" strandboard		
		strand-board "strand board" waferboard		
		wafer-board "wafer board") and ("press		
		coat" "press coated" "press coating")		
5	1	1 '	USPAT	2003/07/15 10:20
6 8	16	5059264.URPN.	USPAT	2003/07/15 10:03
9	16	("3983307"   "4017434"   "4505986").PN.   5059264.URPN.	USPAT USPAT	2003/07/15 10:03 2003/07/15 10:04
10	10	("5741823").PN.	USPAT	2003/07/15 10:04
	31	("3098785"   "3607341"   "3790421"	USPAT	2003/07/15 10:41
		"3804700"   "3901240"   "3919451"		2000,01,10 10120
		"3933691"   "3957940"   "3961118"		
		"4061822"   "4238438"   "4265965"		
		"4289823"   "4325856"   "4376142"		
		"4384096"   "4385152"   "4403003"		
		"4510268"   "4517228"   "4654397"		
1		"4692473"   "4734231"   "4814373"   "4966170"   "5059364"   "5063646"		
		"4966170"   "5059264"   "5063646"     "5085891"   "5109030"   "5360826"		
		"5436069").PN.		
12	0	SHEETS-Harold(in)	USPAT;	2003/07/15 10:42
			EPO; JPO;	2000, 01, 20 20112
			DERWENT	
13	1	SHEETS-Harold-J[in]	USPAT;	2003/07/15 10:42
			EPO; JPO;	
1.,			DERWENT	
14	42		USPAT;	2003/07/15 10:43
		<pre>chip\$lboard partcile\$lboard hard\$lboard flake\$lboard strand\$lboard wafer\$lboard)</pre>	EPO; JPO;	
		liakesiboard strandsiboard waiersiboard)   and GLIDDEN[as]	DERWENT	
15	13	• •	USPAT;	2003/07/15 10:43
	-5	chip\$lboard partcile\$lboard hard\$lboard	EPO; JPO;	2003/01/13 10:43
		flake\$1board strand\$1board wafer\$1board)	DERWENT	
		and GLIDDEN(as) and seal\$4		
16	5	, , , , , , , , , , , , , , , , , , , ,	USPAT;	2003/07/15 10:47
		chip\$1board partcile\$1board hard\$1board	EPO; JPO;	
		<pre>flake\$1board strand\$1board wafer\$1board)</pre>	DERWENT	
[ ]		and GLIDDEN[as] and seal\$4 and (primer		
1,, 1	_	primed multi\$1layer)	1	
17	3	((wood wooden cellulosic fiber\$1board	USPAT;	2003/07/15 10:45
1		<pre>chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board)</pre>	EPO; JPO;	
	ĺ	and GLIDDEN[as] and seal\$4 and (primer	DERWENT	
	l	primed multi\$1layer)) not 5059264[pn]		
18	1		USPAT	2003/07/15 10:45
19		("3983307"   "4017434"   "4505986").PN.	USPAT	2003/07/15 10:45
20		5059264.URPN.	USPAT	2003/07/15 10:45
	-		•	

WPF 07/15/03

21	35	<pre>(wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and HSU[in] and (primer primed</pre>	USPAT; EPO; JPO; DERWENT	2003/07/15 11:01
į l		multi\$1layer)		
22	283	(wood wooden cellulosic fiber\$lboard chip\$lboard partcile\$lboard hard\$lboard flake\$lboard strand\$lboard wafer\$lboard) and (multi\$llayer same (ultra\$lviolet	USPAT; EPO; JPO; DERWENT	2003/07/15 11:02
23	135	"UV")) (wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (multi\$1layer same (ultra\$1violet "UV")) and (primed primer sealed sealing sealant)	USPAT; EPO; JPO; DERWENT	2003/07/15 11:03
24	· 172	(wood wooden cellulosic fiber\$lboard chip\$lboard partcile\$lboard hard\$lboard flake\$lboard strand\$lboard wafer\$lboard) and (multi\$llayer same ((ultra\$lviolet "UV") with cure cured curing)) and (primed	USPAT; EPO; JPO; DERWENT	2003/07/15 11:03
	112	primer sealed sealing sealant) (wood wooden cellulosic fiber\$lboard chip\$lboard partcile\$lboard hard\$lboard flake\$lboard strand\$lboard wafer\$lboard) and (multi\$llayer same ((ultra\$lviolet "UV") with cure cured curing)) and (sealed sealing sealant)	USPAT; EPO; JPO; DERWENT	2003/07/15 11:13
26	6	(("4072770") or ("4082882") or ("5212271") or ("5453451") or ("5584496") or ("5740941")).PN.	USPAT	2003/07/15 11:11
27	1	("5453451").PN.	USPAT	2003/07/15 11:11
28	130	<pre>(wood wooden cellulosic fiber\$lboard chip\$lboard partcile\$lboard hard\$lboard flake\$lboard strand\$lboard wafer\$lboard) and (top\$lcoat\$3 same ((ultra\$lviolet "UV") with cure cured curing)) and (sealed sealing sealant)</pre>	USPAT; EPO; JPO; DERWENT	2003/07/15 11:14
29	125	(wood wooden cellulosic fiber\$lboard chip\$lboard partcile\$lboard hard\$lboard flake\$lboard strand\$lboard wafer\$lboard) and (top\$lcoat\$3 same ((ultra\$lviolet "UV") with cure cured curing)) and (sealed sealing sealant)	USPAT	2003/07/15 11:46
30	126	(wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (top\$1coat\$3 same ((ultra\$1violet "UV") with cure cured curing)) and (primed primer priming sealed sealing sealant)	USPAT ·	2003/07/15 11:50
31	52	(wooden fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (top\$1coat\$3 same ((ultra\$1violet "UV") with cure cured curing)) and (primed primer priming sealed sealing sealant)	USPAT	2003/07/15 12:12
32	690	<pre>(wooden fiber\$lboard chip\$lboard partcile\$lboard hard\$lboard flake\$lboard strand\$lboard wafer\$lboard) and ((coating near3 line))</pre>	USPAT	2003/07/15 12:16
33	14	((wooden fiber\$lboard chip\$lboard partcile\$lboard hard\$lboard flake\$lboard strand\$lboard wafer\$lboard) and ((coating near3 line) (production near3 line))) and primer and top\$lcoat\$3	USPAT	2003/07/15 12:13
34	140	(wooden fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) and (coating near3 line)	USPAT	2003/07/15 12:16

35	13	• •	USPAT	2003/07/15 12:16
		partcile\$1board hard\$1board flake\$1board		
		strand\$1board wafer\$1board) and (coating		
	_	near3 line)) and primer and top\$1coat\$3		0000/07/15 10 16
36	0	1 ,,,	USPAT	2003/07/15 12:16
		partcile\$1board hard\$1board flake\$1board		
		strand\$1board wafer\$1board) and (coating		
		near3 line)) and primer and top\$1coat\$3)		
•		not (((wooden fiber\$1board chip\$1board		
		partcile\$1board hard\$1board flake\$1board		
		strand\$1board wafer\$1board) and ((coating		
		near3 line) (production near3 line))) and		
27	107	primer and top\$1coat\$3)	USPAT	2003/07/15 12:17
37	127	((wooden fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board	USFAI	2003/07/13 12:17
		strand\$1board wafer\$1board) and (coating		
		near3 line)) not (((wooden fiber\$lboard		
		chip\$1board partcile\$1board hard\$1board		
·		flake\$1board strand\$1board wafer\$1board)		
		and ((coating near3 line) (production		
		near3 line))) and primer and top\$1coat\$3)		
l <u> </u>	4045		USPAT;	2003/07/14 16:01
	1043	(427/238) or $(427/309)$ or $(427/370)$ or $(427/408)$ or	EPO; JPO;	
		(427/412.2)).CCLS.	DERWENT	
_	66		USPAT;	2003/07/14 16:01
	00	(427/371) or (427/407.1) or (427/408) or	EPO; JPO;	2000,01,22
		(427/412.2)).CCLS.) and (press\$3 near3	DERWENT	
	1	bond\$3)		
l _	26	I	USPAT;	2003/07/14 16:25
		(427/371) or (427/407.1) or (427/408) or	EPO; JPO;	
	ļ	(427/412.2)).CCLS.) and (press\$3 near3	DERWENT	
		bond\$3)) and (wood wooden cellulosic		
		fiber\$1board chip\$1board partcile\$1board)		
l <b>-</b>	و ا	· · · · · · · · · · · · · · · · · · ·	USPAT;	2003/07/14 16:22
	1	(427/371) or (427/407.1) or (427/408) or	EPO; JPO;	
		(427/412.2)).CCLS.) and (press\$3 near3	DERWENT	1
		bond\$3)) and (wood wooden cellulosic		
		fiber\$1board chip\$1board partcile\$1board))		
1		and (coat\$3 near3 cur\$4)		
-	2	((((((427/258) or (427/369) or (427/370)	USPAT;	2003/07/14 16:03
		or (427/371) or (427/407.1) or (427/408)	EPO; JPO;	·
		or (427/412.2)).CCLS.) and (press\$3 near3	DERWENT	
		bond\$3)) and (wood wooden cellulosic	l	
		fiber\$1board chip\$1board partcile\$1board))		
1		and (coat\$3 near3 cur\$4)) and (("UV"	1	
1	-	ultra\$1violet) near3 cur\$4)		0000/07/11 16 00
-	0	(((((((427/258) or (427/369) or (427/370)	USPAT;	2003/07/14 16:03
		or (427/371) or (427/407.1) or (427/408)	EPO; JPO;	
1		or (427/412.2)).CCLS.) and (press\$3 near3	DERWENT	
		bond\$3)) and (wood wooden cellulosic		
[		fiber\$1board chip\$1board partcile\$1board))		
	l	and (coat\$3 near3 cur\$4)) and (("UV"	1	
		ultra\$1violet) near3 cur\$4)) and (primer	1	
	1 ^	primed priming)	HCDAT.	2003/07/14 16:06
-	2	1 1111111111111111111111111111111111111	USPAT; EPO; JPO;	2003/07/14 10:00
1		or (427/371) or (427/407.1) or (427/408)	DERWENT	
1		or (427/412.2)).CCLS.) and (press\$3 near3	DEKMENI	
1		bond\$3)) and (wood wooden cellulosic		
1		fiber\$lboard chip\$lboard partcile\$lboard))	1	
1		and (coat\$3 near3 cur\$4)) and (("UV"		
		ultra\$1violet) near3 cur\$4)) and (prime primer primed priming)		
l	812	primer primed priming)   "press coating"	USPAT;	2003/07/14 16:07
l -	012	press coacing	EPO; JPO;	=====================================
			DERWENT	
l _	13	(((427/258) or (427/369) or (427/370) or	USPAT;	2003/07/14 16:07
	13	(427/371) or (427/407.1) or (427/408) or	EPO; JPO;	
		(427/412.2)).CCLS.) and "press coating"	DERWENT	
	<del></del>	1 (12.7 112.277.0020.7 did press couring	1 221112111	L

-	7	((((((427/258) or (427/369) or (427/370)	USPAT;	2003/07/14 16:22
		or (427/371) or (427/407.1) or (427/408)	EPO; JPO;	1
		or (427/412.2)).CCLS.) and (press\$3 near3	DERWENT	
		bond\$3)) and (wood wooden cellulosic		1
		<pre>fiber\$1board chip\$1board partcile\$1board))</pre>		
		and (coat\$3 near3 cur\$4)) not		
		(((((((427/258) or (427/369) or (427/370)		
		or (427/371) or (427/407.1) or (427/408)		
		or (427/412.2)).CCLS.) and (press\$3 near3		
		bond\$3)) and (wood wooden cellulosic		
		<pre>fiber\$1board chip\$1board partcile\$1board))</pre>	ļ	į
		and (coat\$3 near3 cur\$4)) and (("UV"		
		ultra\$1violet) near3 cur\$4))		
-	1122	,,,	USPAT;	2003/07/14 16:28
		chip\$1board partcile\$1board hard\$1board	EPO; JPO;	
		flake\$1board strand\$1board wafer\$1board)	DERWENT	
		with coat\$3) same ((press\$3 near3 coat\$3)		
		(heat\$3 near3 press\$3)))		
_	9	(((wood wooden cellulosic fiber\$1board	USPAT;	2003/07/14 16:37
		chip\$1board partcile\$1board hard\$1board	EPO; JPO;	
		flake\$1board strand\$1board wafer\$1board)	DERWENT	
		with coat\$3) same ((press\$3 near3 coat\$3)		
		(heat\$3 near3 press\$3))) and (top\$1coat\$3		
	•	same ("UV" ultra\$1violet))		
-	51	(,	USPAT;	2003/07/14 16:38
		chip\$1board partcile\$1board hard\$1board	EPO; JPO;	
		flake\$1board strand\$1board wafer\$1board)	DERWENT	
		with coat\$3) same ((press\$3 near3 coat\$3)		1
		(heat\$3 near3 press\$3)) same (seal\$4)		
-	50	1 ( ( ( ) ) )	USPAT;	2003/07/15 09:41
•		chip\$1board partcile\$1board hard\$1board	EPO; JPO;	
		flake\$1board strand\$1board wafer\$1board)	DERWENT	
		with coat\$3) same ((press\$3 near3 coat\$3)		
		(heat\$3 near3 press\$3)) same (seal\$4)) not		
	1	((((wood wooden cellulosic fiber\$1board		]
		chip\$1board partcile\$1board hard\$1board		
		flake\$1board strand\$1board wafer\$1board)		
		with coat\$3) same ((press\$3 near3 coat\$3)		
		(heat\$3 near3 press\$3))) and (top\$1coat\$3		
		same ("UV" ultra\$lviolet)))		